



### HIGH-SIDE AND LOW-SIDE GATE DRIVER IN SO-8

### **Description**

The DGD2106M is a High-voltage / High-speed gate driver capable of driving N-Channel MOSFETs and IGBTs in a High-Side/Low-Side configuration. High voltage processing techniques enable the DGD2106M's high-side to switch to 600V in a bootstrap operation.

The DGD2106M logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with controlling devices. The driver outputs feature high pulse current buffers designed for minimum driver cross conduction.

The DGD2106M is available in a space saving SO-8 package and operates over an extended -40°C to +125°C temperature range.

### **Applications**

- DC-DC Converters
- DC-AC Inverters
- AC-DC Power Supplies
- Motor Controls
- Class D Power Amplifiers

# Vcc Vcc Vb Hin DGD2106M Vs COM LO

Typical Configuration

### **Features**

- Floating High-Side Driver in Bootstrap Operation to 600V
- Drives Two N-Channel MOSFETs or IGBTs in High-Side/Low-Side Configuation
- Outputs Tolerant to Negative Transients
- Wide Logic and Low-Side Gate Driver Supply Voltage: 10V to 20V
- Logic Input (HIN and LIN) 3.3V Capability
- Schmitt Triggered Logic Inputs with Internal Pull Down
- Undervoltage Lockout for V<sub>CC</sub>
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

- Case: SO-8 (Standard)
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.075 grams (Approximate)



SO-8 Top View

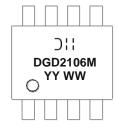
### **Ordering Information** (Note 4)

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DGD2106MS8-13	DGD2106M	13	12	2,500

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

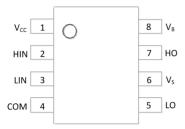
### **Marking Information**



J;; = Manufacturer's Marking
DGD2106M = Product Type Marking Code
YY = Year (ex: 21 = 2021)
WW or WW- = Week (01 to 53)



# **Pin Diagrams**

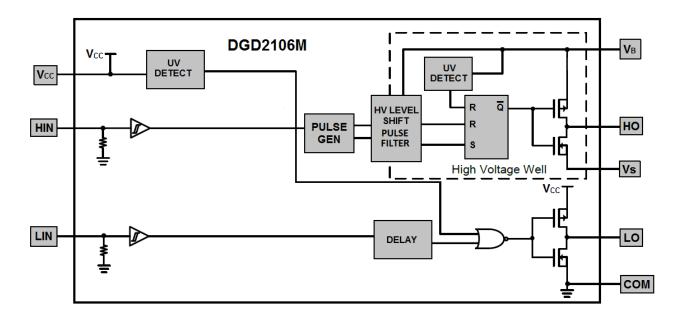


Top View: SO-8

# **Pin Descriptions**

Pin Number	Pin Name	Function	
1	Vcc	Low-Side and logic fixed supply	
2	HIN	Logic input for High-Side gate driver output, in phase with HO	
3	LIN	Logic input for Low-Side gate driver output, in phase with LO	
4	COM	Logic and Low-Side return	
5	LO	Low-Side gate drive output	
6	Vs	High-Side floating supply return	
7	НО	High-Side gate drive output	
8	V <sub>B</sub>	High-Side floating supply	

# **Functional Block Diagram**





# **Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage	$V_{B}$	-0.3 to +624	V
High-Side Floating Supply Offset Voltage	Vs	V <sub>B</sub> -24 to V <sub>B</sub> +0.3	V
High-Side Floating Output Voltage	Vно	Vs-0.3 to V <sub>B</sub> +0.3	٧
Offset Supply Voltage Transient	dV <sub>S</sub> / dt	50	V/ns
Low-Side and Logic Fixed Supply Voltage	Vcc	-0.3 to +24	٧
Low-Side Output Voltage	$V_{LO}$	-0.3 to V <sub>CC</sub> +0.3	V
Logic Input Voltage (HIN and LIN)	Vin	-0.3 to Vcc+0.3	V

# Thermal Characteristics ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	P <sub>D</sub>	0.625	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	200	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

# **Recommended Operating Conditions**

Parameter	Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage	V <sub>B</sub>	V <sub>S</sub> + 10	V <sub>S</sub> + 20	V
High Side Floating Supply Offset Voltage	Vs	(Note 6)	600	V
High Side Floating Output Voltage	Vно	Vs	VB	V
Low Side and Logic Fixed Supply Voltage	Vcc	10	20	V
Low Side Output Voltage	VLO	0	Vcc	V
Logic Input Voltage	Vin	0	5	V
Ambient Temperature	TA	-40	+125	°C

Note: 6. Logic operation for  $V_S$  of -5V to +600V.



### DC Electrical Characteristics (VBIAS (VCC, VBS) = 15V, @TA = +25°C, unless otherwise specified.) (Note 7)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Logic "1" Input Voltage	VIH	2.5	_	_	V	V <sub>CC</sub> = 10V to 20V
Logic "0" Input Voltage	VIL	_	_	0.6	V	Vcc = 10V to 20V
High Level Output Voltage, V <sub>BIAS</sub> - V <sub>O</sub>	Voн	_	0.05	0.2	V	$I_O = 2mA$
Low Level Output Voltage, Vo	Vol	_	0.02	0.1	V	Io = 2mA
Offset Supply Leakage Current	ILK	_	_	50	μΑ	$V_B = V_S = 600V$
Quiescent V <sub>BS</sub> Supply Current	I <sub>BSQ</sub>	20	75	130	μΑ	$V_{IN} = 0V \text{ or } 5V$
Quiescent Vcc Supply Current	Iccq	60	120	180	μΑ	VIN = 0V or 5V
Logic "1" Input Bias Current	I <sub>IN+</sub>	_	5.0	20	μΑ	VIN = 5V
Logic "0" Input Bias Current	I <sub>IN</sub> -	_	_	2.0	μΑ	VIN = 0V
V <sub>BS</sub> Supply Undervoltage Positive Going Threshold	V <sub>BSUV+</sub>	7.0	8.4	9.8	V	_
V <sub>BS</sub> Supply Undervoltage Negative Going Threshold	$V_{BSUV}$	6.4	7.8	9.0	V	_
Vcc Supply Undervoltage Positive Going Threshold	Vccuv+	7.0	8.4	9.8	V	_
V <sub>CC</sub> Supply Undervoltage Negative Going Threshold	V <sub>CCUV</sub> -	6.4	7.8	9.0	V	_
Hysterisis	Vссиvн	0.3	0.7	_	V	_
Hysterisis	VBSUVH	0.3	0.7	_	V	_
Output High Short Circuit Pulsed Current	I <sub>O+</sub>	130	290	_	mA	V <sub>O</sub> = 0V, PW ≤ 10μs
Output Low Short Circuit Pulsed Current	lo-	270	600	_	mA	V <sub>O</sub> = 15V, PW ≤ 10μs

Notes: 7. The V<sub>IN</sub> and I<sub>IN</sub> parameters are referenced to COM and are applicable to the two logic pins: HIN and LIN. The V<sub>O</sub> and I<sub>O</sub> parameters are referenced to COM and are applicable to the respective output pins: HO and LO.

### AC Electrical Characteristics (VBIAS (VCC, VBS) = 15V, CL = 1000pF, @TA = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Turn-On Propagation Delay	ton	_	100	300	ns	Vs = 0V
Turn-Off Propagation Delay	toff	_	100	280	ns	Vs = 0V or 600V
Delay Matching	tом	_	_	30	ns	_
Turn-On Rise Time	t <sub>R</sub>	_	90	220	ns	Vs = 0V
Turn-Off Fall Time	t <sub>F</sub>	_	30	80	ns	Vs = 0V



# **Timing Waveforms**

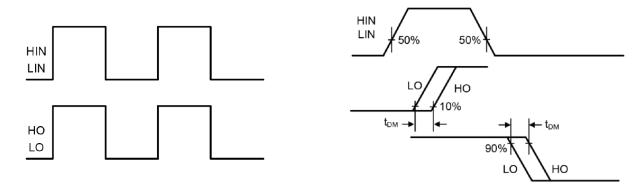


Figure 1. Input / Output Timing Diagram

Figure 2. Delay Matching Waveform Definitions

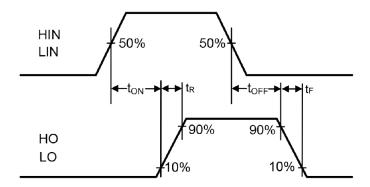


Figure 3. Switching Time Waveform Definitions



### Typical Performance Characteristics (@T<sub>A</sub> = +25°C, V<sub>CC</sub> = 15V, unless otherwise specified.)

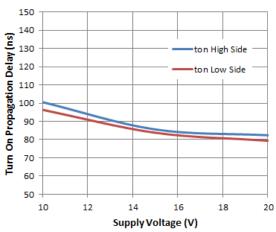


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

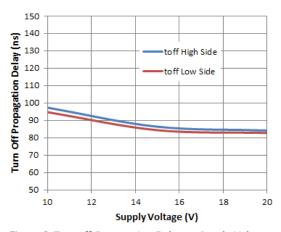


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

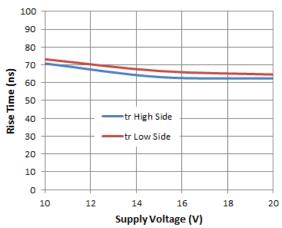


Figure 8. Rise Time vs. Supply Voltage

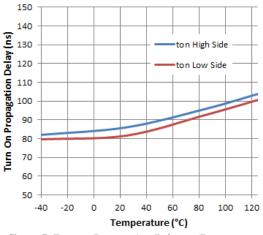


Figure 5. Turn-on Propagation Delay vs. Temperature

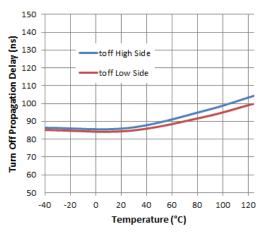


Figure 7. Turn-off Propagation Delay vs. Temperature

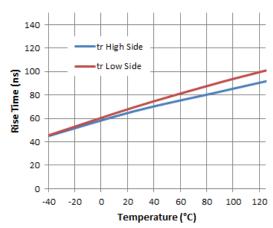


Figure 9. Rise Time vs. Temperature



### **Typical Performance Characteristics** (continued)

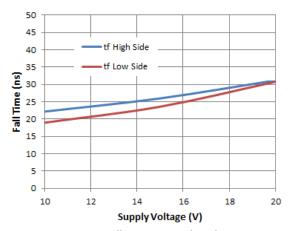


Figure 10. Fall Time vs. Supply Voltage

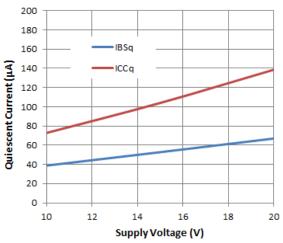


Figure 12. Quiescent Current vs. Supply Voltage

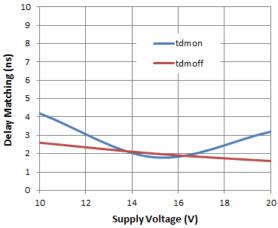


Figure 14. Delay Matching vs. Supply Voltage

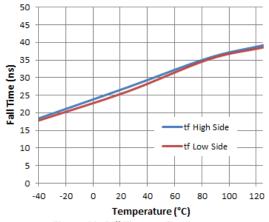


Figure 11. Fall Time vs. Temperature

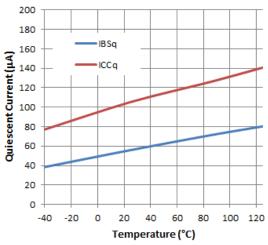


Figure 13. Quiescent Current vs. Temperature

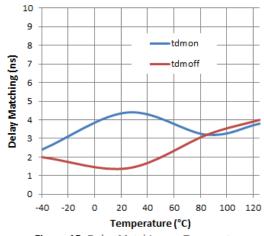


Figure 15. Delay Matching vs. Temperature



### **Typical Performance Characteristics** (continued)

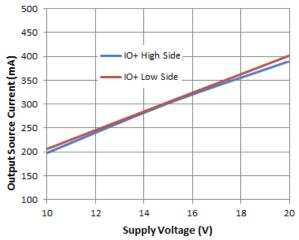


Figure 16. Output Source Current vs. Supply Voltage

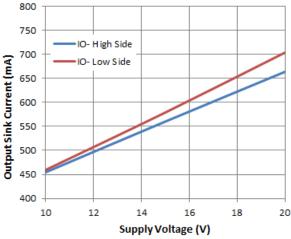


Figure 18. Output Sink Current vs. Supply Voltage

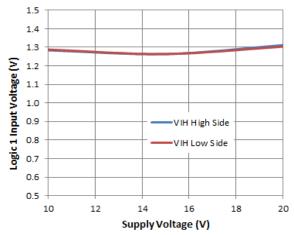


Figure 20. Logic 1 Input Voltage vs. Supply Voltage

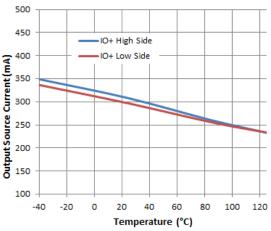


Figure 17. Output Source Current vs. Temperature

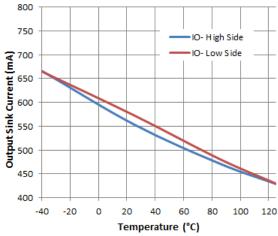


Figure 19. Output Sink Current vs. Temperature

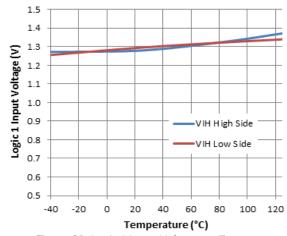


Figure 21. Logic 1 Input Voltage vs. Temperature



### **Typical Performance Characteristics** (continued)

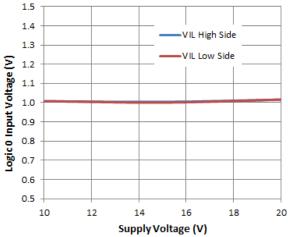


Figure 22. Logic 0 Input Voltage vs. Supply Voltage

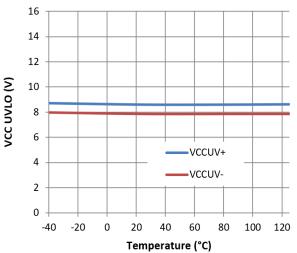


Figure 24. VCC UVLO vs. Temperature

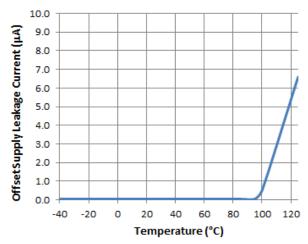


Figure 26. Offset Supply Leakage Current vs. Temperature

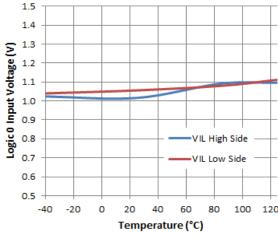


Figure 23. Logic 0 Input Voltage vs. Temperature

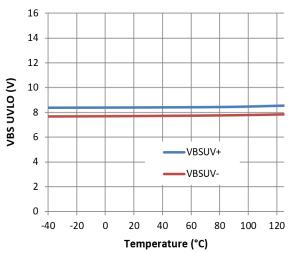


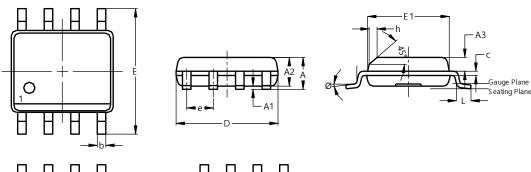
Figure 25. VBS UVLO vs. Temperature



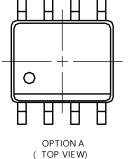
### **Package Outline Dimensions**

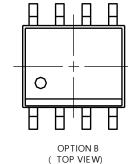
Please see http://www.diodes.com/package-outlines.html for the latest version.

### SO-8 (Standard)



SO-8 (Standard)					
Dim	Min	Max	Тур		
Α		1.75			
A1	0.10	0.25			
A2	1.25	1.65			
A3	0.50	0.70			
b	0.30	0.51			
C	0.15	0.25			
D	4.80	5.00			
Е	5.80	6.20	6.00		
E1	3.80	4.00			
е			1.27		
h	0.25	0.50			
٦	0.45	0.82			
Ø	0°	8°			
All Dimensions in mm					

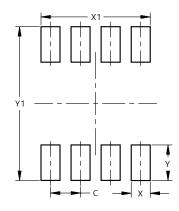




# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SO-8 (Standard)



<b>Dimensions</b>	Value (in mm)
C	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50

Note:

For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.



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